



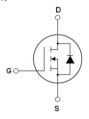
N-Channel Super Junction Power MOSFET III

General Description

The series of devices use advanced super junction technology and design to provide excellent R_{DS(ON)} with low gate charge. This super junction MOSFET fits the industry's AC-DC SMPS requirements for PFC, AC/DC power conversion, and industrial power applications.

Features

- ◆ New technology for high voltage device
- ◆ Low on-resistance and low conduction losses
- ◆ Small package
- ◆ Ultra Low Gate Charge cause lower driving requirements
- ◆ 100% Avalanche Tested
- ROHS compliant





Schematic diagram

TO-220F

Application

- ◆ Power factor correction (PFC)
- Switched mode power supplies(SMPS)
- ◆ Uninterruptible Power Supply (UPS)

V _D s	650	V
R _{DS(ON)MAX}	180	mΩ
ID	21	А

Package Marking And Ordering Information

Device Device Packag		Marking
MJ65T180F	TO-220F	MJ65T180F

Table 1. Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	MJ65T180F	Unit
Drain-Source Voltage (Vcs=0V)	VDS	650	V
Gate-Source Voltage (V _{DS} =0V) AC (f>1 Hz)	Vgs	±30	V
Continuous Drain Current at Tc=25°C	ID (DC)	21*	Α
Continuous Drain Current at Tc=100°C	ID (DC)	13.2*	А
Pulsed drain current (Note 1)	IDM (pluse)	84*	А
Maximum Power Dissipation (Tc=25°C)	Po	33.8	W
Derate above 25°C	PD	0.27	W/°C
Single pulse avalanche energy (Note 2)	Eas	441	mJ
Avalanche current (Note 1)	lar	10.5	А
Repetitive Avalanche energy, tar limited by T _{jmax} (Note 1)	Ear	0.7	mJ

Parameter	Symbol	MJ65T180F	Unit
Drain Source voltage slope, V _{DS} ≤480 V	dv/dt	50	V/ns
Reverse diode dv/dt, V _{DS} ≤480 V,I _{SD} <i<sub>D</i<sub>	dv/dt	15	V/ns
Operating Junction and Storage Temperature Range	TJ,Tsтg	-55+150	°C





Table 2. Thermal Characteristic

Parameter	Symbol	MJ65T180F	Unit
Thermal Resistance, Junction-to-Case (Maximum)	RthJC	3.69	°C/W
Thermal Resistance, Junction-to-Ambient (Maximum)	RthJA	80	°C/W

Table 3. Electrical Characteristics (T_A=25℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
On/off states						
Drain-Source Breakdown Voltage	BVDSS	V _{DSS} V _{GS} =0V I _D =250μA		-	-	V
Zero Gate Voltage Drain Current (Tc=25°C)	loss	V _{DS} =650V,V _{GS} =0V	-	0.05	1	μA
Zero Gate Voltage Drain Current (Tc=125°C)	loss	V _{DS} =650V,V _{GS} =0V	_	-	100	μΑ
Gate-Body Leakage Current	lgss	V _{GS} =±20V,V _{DS} =0V	-	-	±100	nA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} ,I _D =250µA	3	3.5	4	V
Drain-Source On-State Resistance	Rds(on)	V _{GS} =10V,I _D =10.5A	-	150	180	mΩ
Dynamic Characteristics				1		
Forward Transconductance	grs	V _{DS} =20V,I _D =10.5A	-	16	-	S
Input Capacitance	Cies		-	2250	_	PF
Output Capacitance	Coss	V _{DS} =50V,V _{GS} =0V F=1.0MHz	-	83	-	PF
Reverse Transfer Capacitance	Crss		-	1.6	_	PF
Total Gate Charge	Qg		-	36	-	nC
Gate-Source Charge	Qgs	V _{DS} =480V,I _D =21A V _{GS} =10V	-	14	-	nC
Gate-Drain Charge	Qgd		-	8.5	_	nC
Switching times						1
Turn-on Delay Time	t _{d(on)}	t _{d(on)} - 11		-	nS	
Turn-on Rise Time	tr	V _{DD} =380V,I _D =11A		_	nS	
Turn-Off Delay Time	t _{d(off)}	R _G =4Ω,V _G s=10V	-	61	-	nS
Turn-Off Fall Time	tr		-	4.5	-	nS
Source- Drain Diode Characteristics						1
Source-drain current (Body Diode)	Isp		-	_	21	А
Pulsed Source-drain current (Body Diode)	Isdm	- Tc=25°C -	_	-	84	А
Forward On Voltage	Vsd	T _j =25°C,I _{SD} =21A,V _{GS} =0V	_	0.9	1.3	V
Reverse Recovery Time	trr		-	310	-	nS
Reverse Recovery Charge	Qrr	Tj=25°C,IF=21A di/dt=100A/µs	-	5	_	uC
Peak reverse recovery Current	Irrm		-	28	_	А

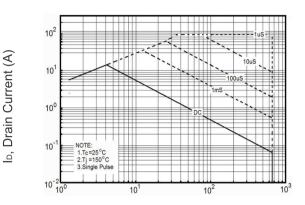




Notes

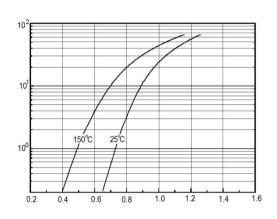
- 1.Repetitive Rating: Pulse width limited by maximum junction temperature
- $2.T_j = 25^{\circ}C, V_{DD} = 50V, V_{G} = 10V, R_{G} = 25\Omega$

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS (curves)



lps, Reverse Drain Current(A)

lb, Drain Current (A)



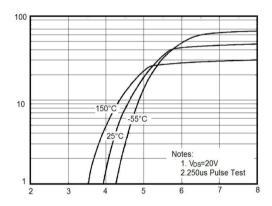
V_{DS}, Drain-Source Voltage (V)

Figure 1 Safe operating area

Tj=25°C VGS 20V 10V 8V 7V 6.5V 6V 5.5V 5V 4.5V

Vsp,Source-Drain Voltage(V)

Figure 2 Source-Drain Diode Forward Voltage



V_{GS}, Gate-Source Voltage (V)

Figure 4 Transfer characteristics

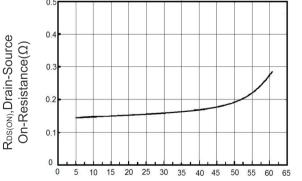
V_{DS}(V)

30

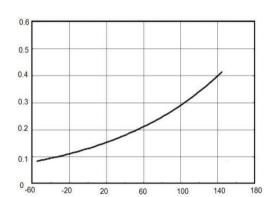
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10

Figure 3 Output characteristics



ADS(ON), Drain-Source On-Resistance(Ω)



ID, Drain Current (A)

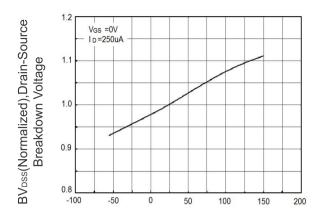
Figure 5 Static drain-source on resistance

T_J, Junction Temperature (°C) Figure 6 RDS(ON) vs Junction Temperature

lo, Drain Current (A)

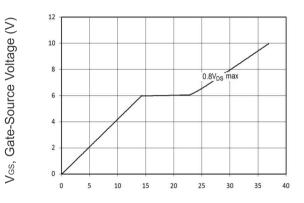
Capacitances(pF)





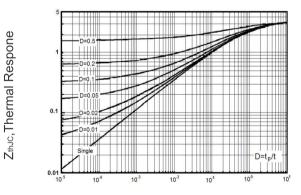
T_J, Junction Temperature (°C)

Figure 7 BVDSS vs Junction Temperature



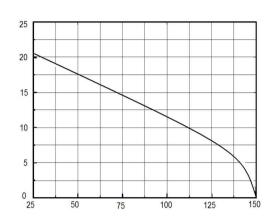
Q_G,Total Gate Charge(nC)

Figure 9 Gate charge waveforms



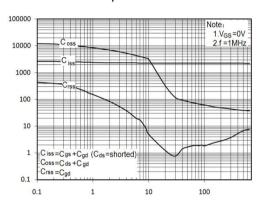
tp,Square Wave Pulse(S)

Figure 11 Transient Thermal Impedance



Tc, Case Temperature (°C)

Figure 8 Maximum ID vs Junction Temperature



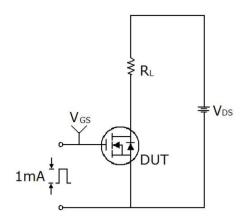
V_{DS}, Drain-Source Voltage (V)

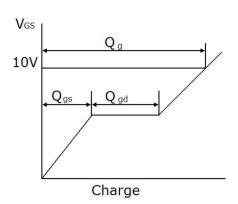
Figure 10 Capacitance



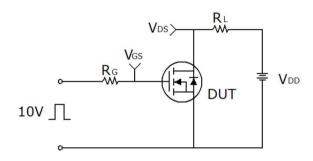


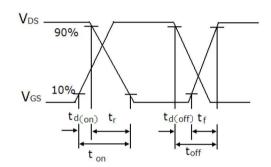
Test circuit



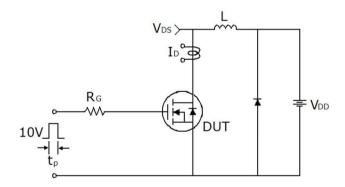


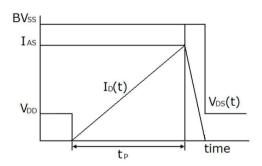
Gate charge test circuit & Waveform





Switch Time Test Circuit



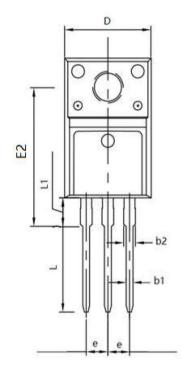


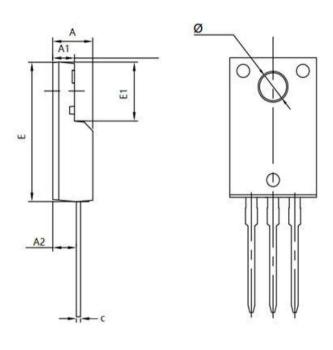
Unclamped Inductive Switching Test Circuit & Waveforms





TO-220F Package Information





Symbol	Dimensions In Millimeters		Dimensions	In Inches
	Min.	Max.	Min.	Max.
А	4.500	4.900	0.177	0.193
A1	2.340	2.740	0.092	0.108
A2	2.560	2.960	0.101	0.117
b1	0.700	0.900	0.028	0.035
b2	1.180	1.580	0.046	0.062
С	0.400	0.600	0.016	0.024
D	9.960	10.360	0.392	0.408
E	15.670	15.970	0.617	0.629
E1	6.500	6.900	0.256	0.272
E2	15.500	16.100	0.610	0.634
е	2.540 TYP		0.100	TYP
Ф	3.080	3.280	0.121	0.129
L	12.640	13.240	0.498	0.521
L1	3.030	3.430	0.119	0.135





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